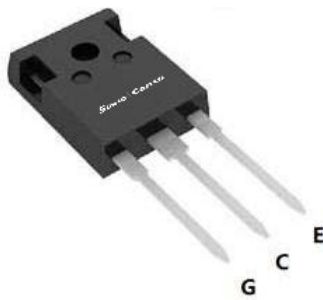




IGBT Discrete

V_{CE}	650	V
I_C	60	A
$V_{CE(SAT)} I_C=60A$	2.10	V

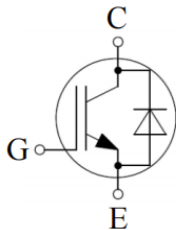
Applications

- High frequency switching application
- Medical applications
- Uninterruptible power supply
- Motion/servo control

Features

- Low switching losses
- Maximum junction temperature 175°C
- Positive temperature coefficient
- High ruggedness, temperature stable
- High short circuit capability(5us)

Circuit



Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	650	V
DC Collector Current, limited by T_{jmax} $T_C=25^{\circ}C$ $T_C=100^{\circ}C$	I_C	120 60	A
Diode Forward Current, limited by T_{jmax} $T_C=25^{\circ}C$ $T_C=100^{\circ}C$	I_F	60 30	A
Continuous Gate-Emitter Voltage	V_{GE}	± 20	V
Transient Gate-Emitter Voltage	V_{GE}	± 30	V
Turn off Safe Operating Area $V_{CE} \leq 1200V$, $T_j \leq 150^{\circ}C$		240	A
Pulsed Collector Current, $V_{GE}=15V$, t_p limited by T_{jmax}	I_{CM}	240	A
Diode Pulsed Current, t_p limited by T_{jmax}	I_{Fpuls}	120	A
Short Circuit Withstand Time, $V_{GE}=15V$, $V_{CC}=400V$, $V_{CEM} \leq 650V$	T_{sc}	5	μs
Power Dissipation, $T_j=175^{\circ}C$, $T_C=25^{\circ}C$	P_{tot}	333	W

Operating Junction Temperature	T_j	-40...+175	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	650		-	V
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=0.8mA$	4.1	5.1	6.1	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=60A$ $T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$ $T_j=150^\circ\text{C}$		2.10 2.40 2.50	2.40	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=650V, V_{GE}=0V$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0.25 4.00	mA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$			100	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V,$ $f=1MHz$	-	2.04	-	nF
Reverse Transfer Capacitance	C_{res}		-	0.84	-	
Gate Charge	Q_G	$V_{CC}=300V, I_C=60A,$ $V_{GE}=15V$	-	0.24	-	uC
Short Circuit Collector Current	I_{SC}	$V_{GE}=15V, t_{sc}\leq 5\mu s,$ $V_{CC}=400V, T_j\leq 150^\circ\text{C}$	-	280	-	A

Electrical Characteristics of the Diode (T_j= 25°C unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Diode Forward Voltage	V _F	I _F = 30A T _j = 25°C, T _j = 125°C T _j = 150°C		1.90 1.85 1.75	2.60	V

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T _j = 25℃						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =60A, V _{GE} = 0V~15V, R _g =10Ω,L _s =60nH	-	18	-	ns
Rise Time	t _r		-	75	-	ns
Turn-on Energy	E _{on}		-	2.84	-	mJ
Turn-off Delay Time	t _{d(off)}		-	163	-	ns
Fall Time	t _f		-	62	-	ns
Turn-off Energy	E _{off}		-	1.21	-	mJ
Dynamic , at T _j = 125℃						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =60A,, V _{GE} = 0V~15V, R _g =10Ω,L _s =60nH	-	17	-	ns
Rise Time	t _r		-	65	-	ns
Turn-on Energy	E _{on}		-	2.86	-	mJ
Turn-off Delay Time	t _{d(off)}		-	176	-	ns
Fall Time	t _f		-	70	-	ns
Turn-off Energy	E _{off}		-	1.41	-	mJ
Dynamic , at T _j = 150℃						
Turn-on Delay Time	t _{d(on)}	V _{CC} =400V, I _C =60A,, V _{GE} = 0V~15V, R _g =10Ω,L _s =60nH	-	16	-	ns
Rise Time	t _r		-	59	-	ns
Turn-on Energy	E _{on}		-	2.98	-	mJ
Turn-off Delay Time	t _{d(off)}		-	182	-	ns
Fall Time	t _f		-	82	-	ns
Turn-off Energy	E _{off}		-	1.51	-	mJ

Electrical Characteristics of the DIODE

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T _j = 25°C						
Reverse Recovery Current	I _{rr}	I _F =30A,V _R =400V di/dt= -350A/μs,	-	7	-	A
Reverse Recovery Charge	Q _{rr}		-	0.14	-	uC
Diode reverse recovery time	trr		-	42	-	ns
Reverse Recovery Energy	E _{rec}		-	0.09	-	mJ
Dynamic , at T _j = 125°C						
Reverse Recovery Current	I _{rr}	I _F =30A,V _R =400V di/dt= -350A/μs,	-	13	-	A
Reverse Recovery Charge	Q _{rr}		-	0.94	-	uC
Diode reverse recovery time	trr		-	153	-	ns
Reverse Recovery Energy	E _{rec}		-	0.22	-	mJ
Dynamic , at T _j = 150°C						
Reverse Recovery Current	I _{rr}	I _F =30A,V _R =400V di/dt= -350A/μs,	-	15	-	A
Reverse Recovery Charge	Q _{rr}		-	1.26	-	uC
Diode reverse recovery time	trr		-	161	-	ns
Reverse Recovery Energy	E _{rec}		-	0.26	-	mJ

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	R _{th(j-c)}	0.45	K/W
Diode Thermal Resistance, Junction - Case	R _{th(j-c)}	1.05	K/W
Thermal Resistance, Junction - Ambient	R _{th(j-a)}	40	K/W

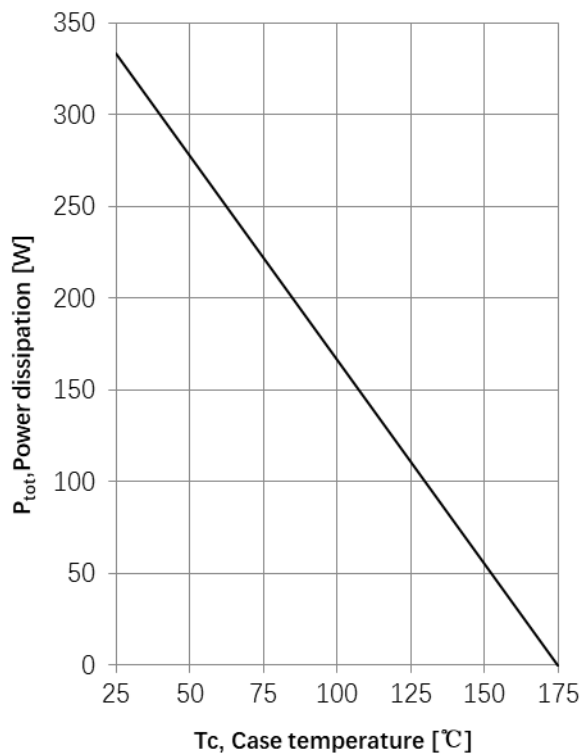


Fig1. Power dissipation as a function of case temperature ($T_j \leq 175^\circ\text{C}$)

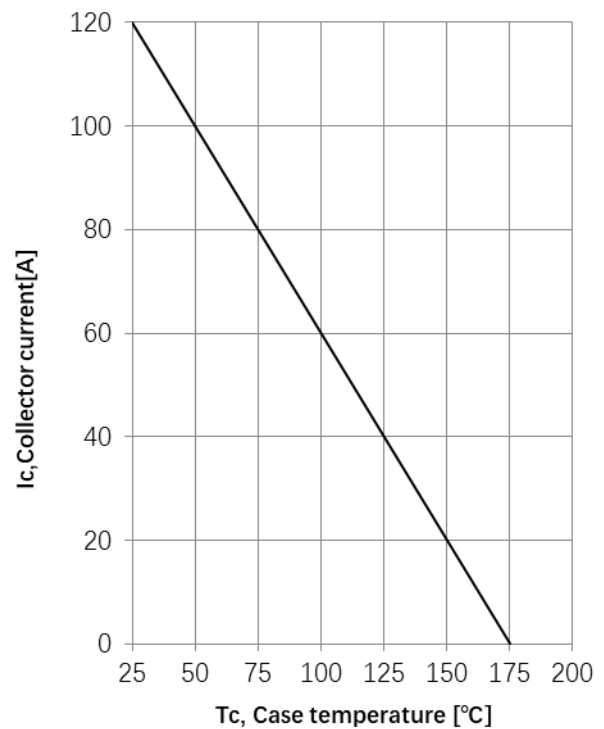


Fig2. Collector current as a function of case temperature ($V_{ge} \geq 15\text{V}$, $T_j \leq 175^\circ\text{C}$)

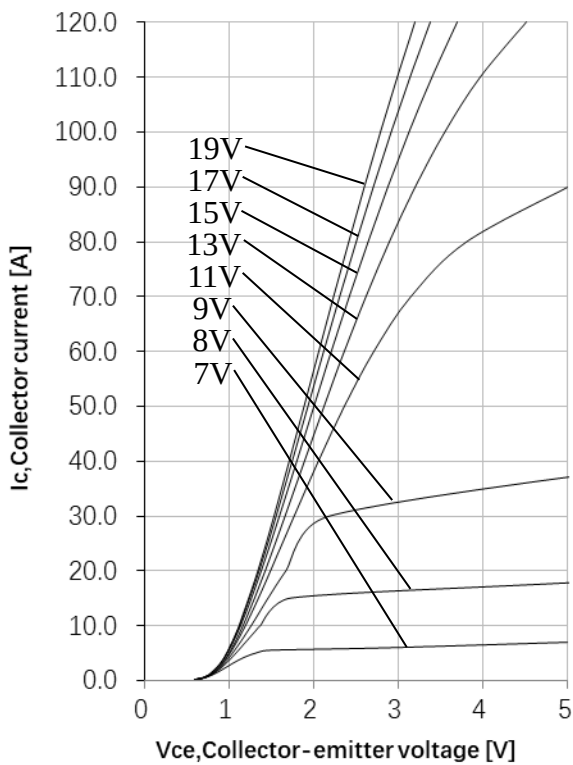


Fig3. Typical output characteristic ($T_j = 25^\circ\text{C}$)

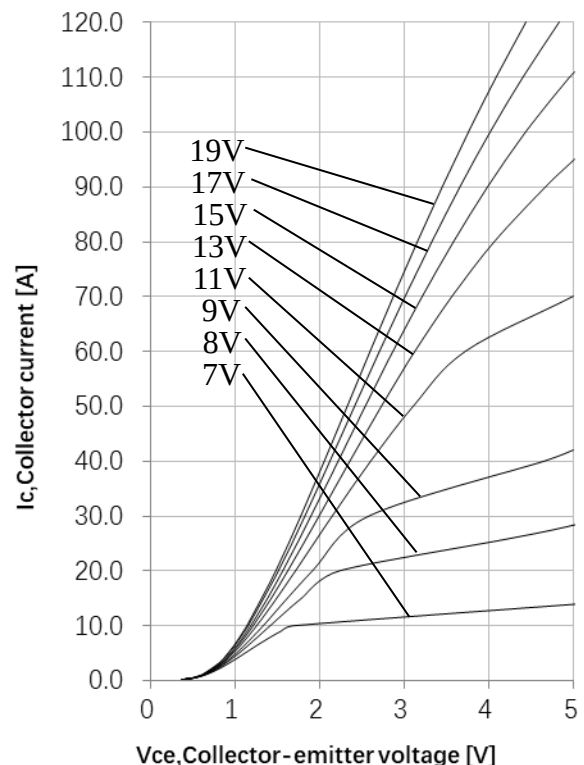
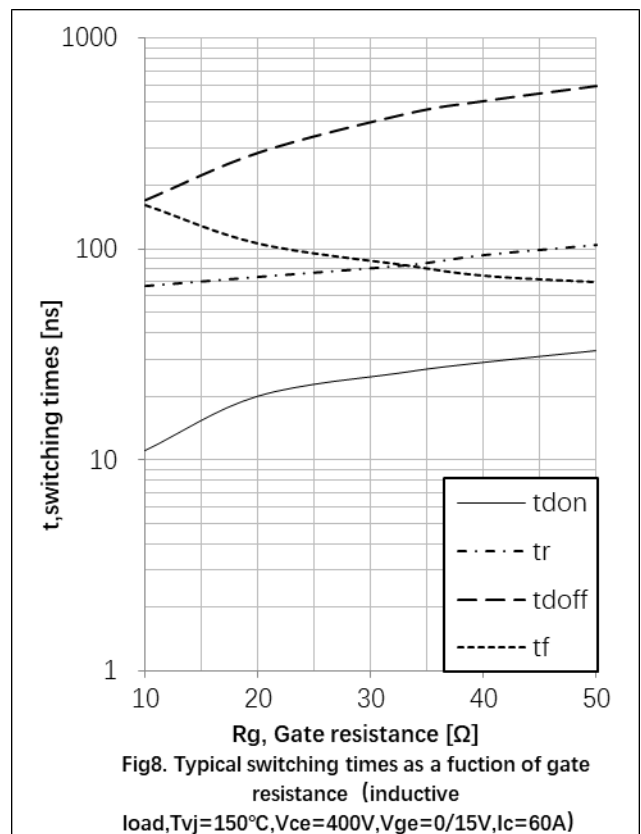
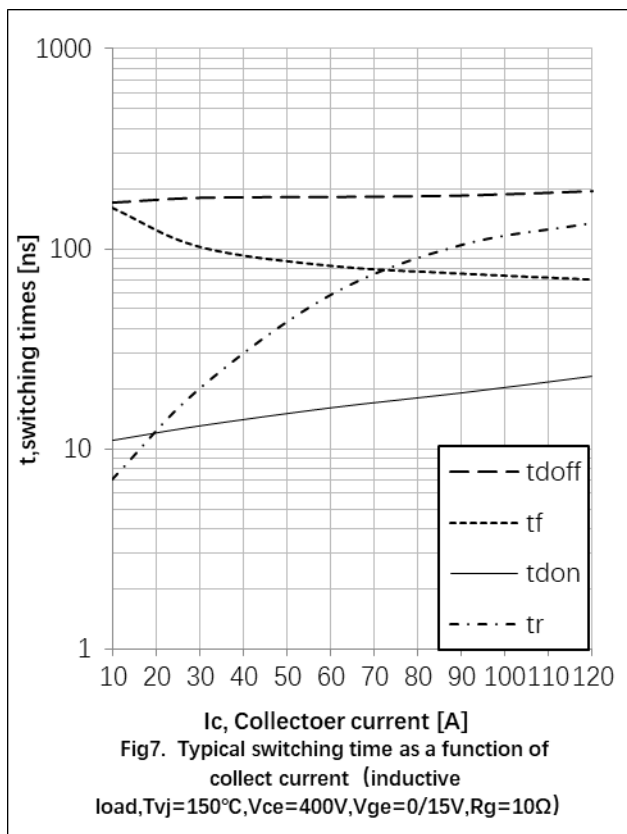
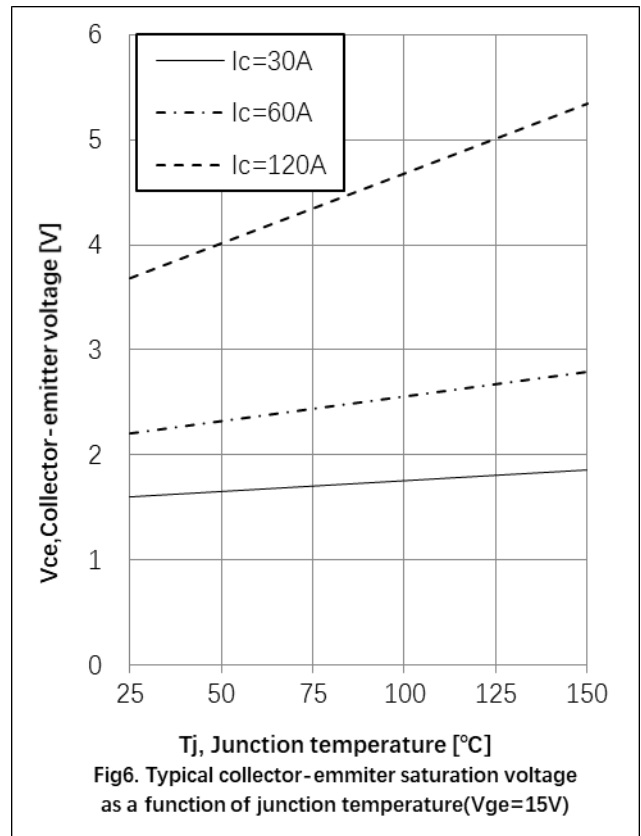
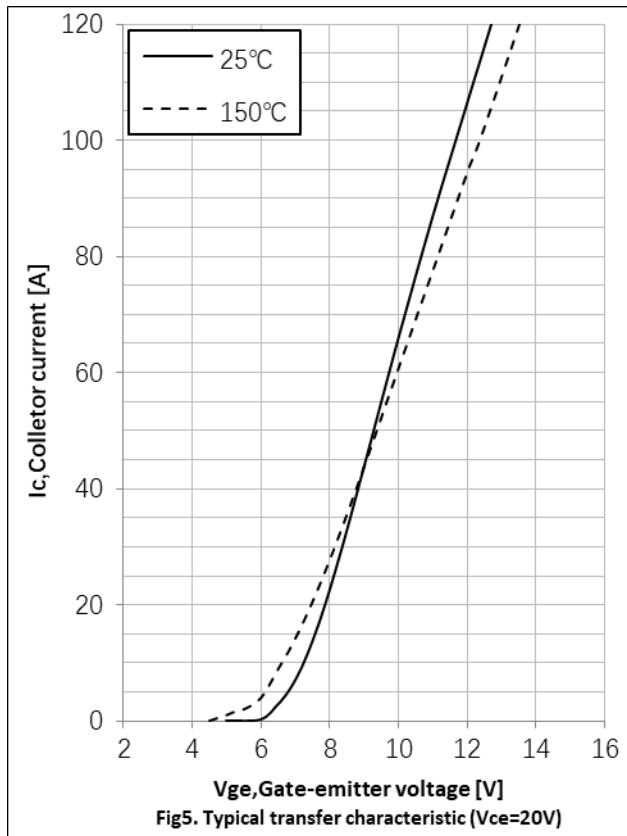
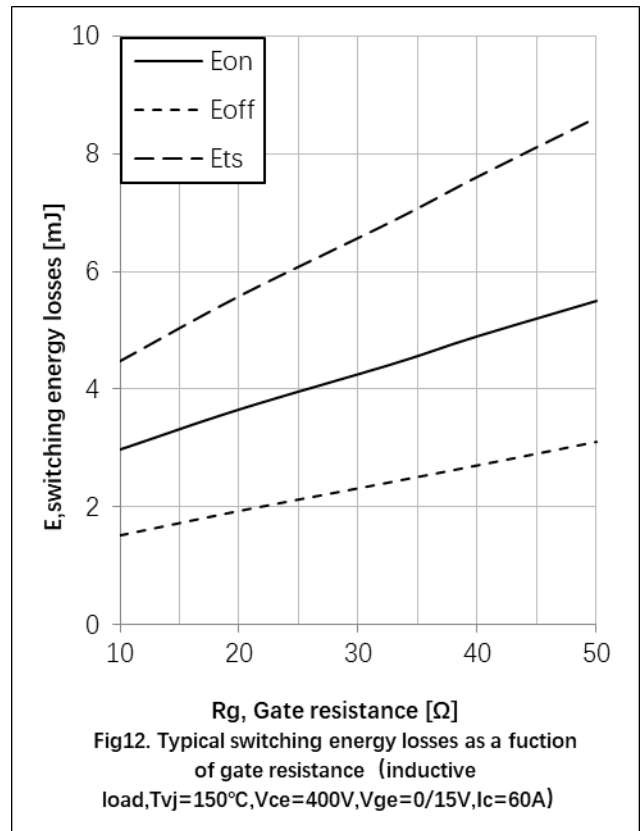
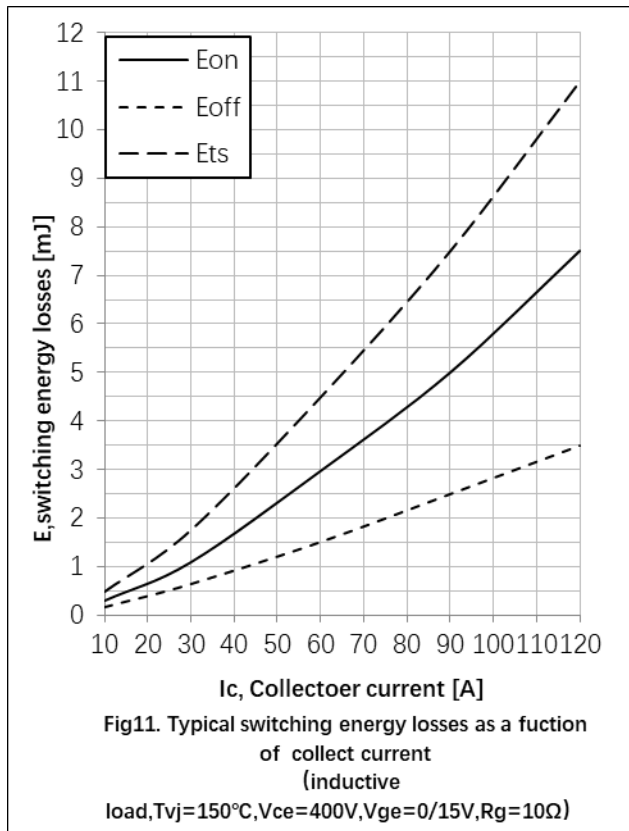
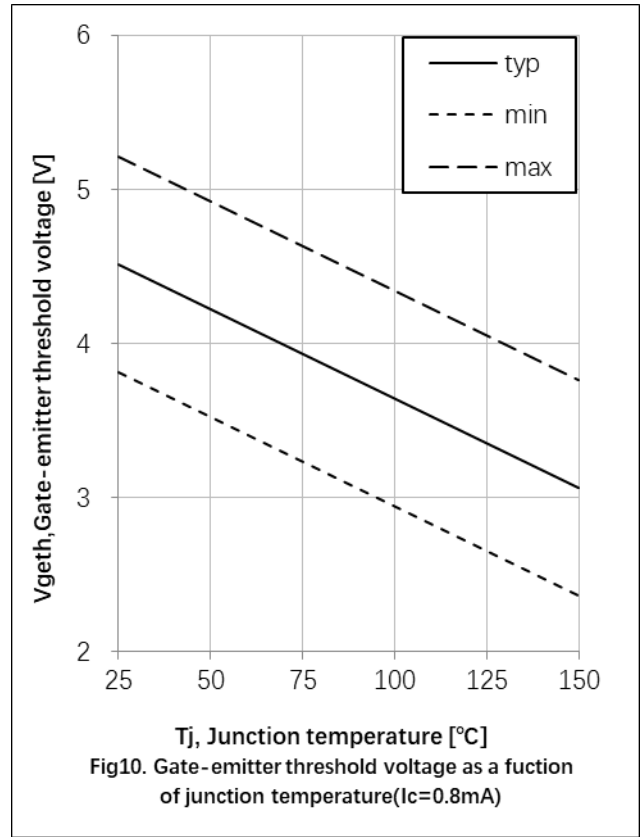
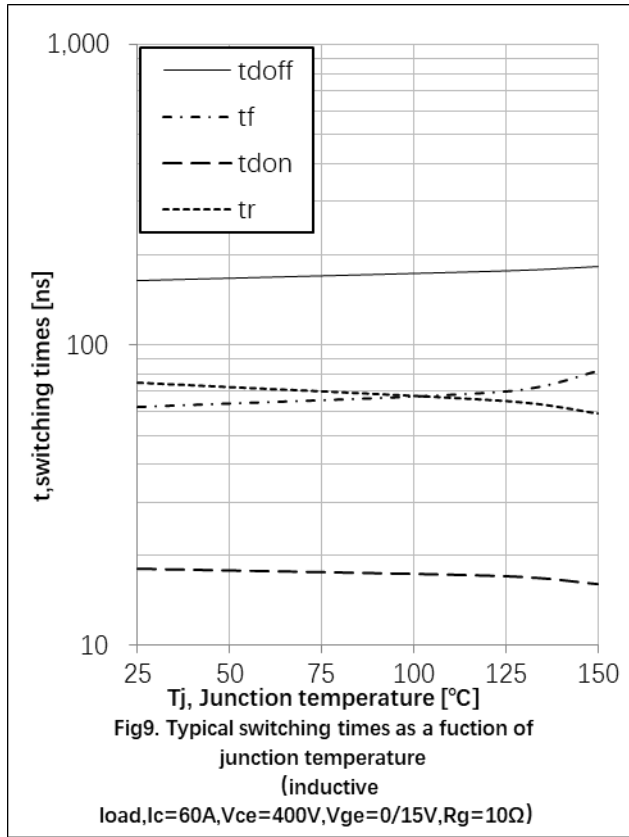
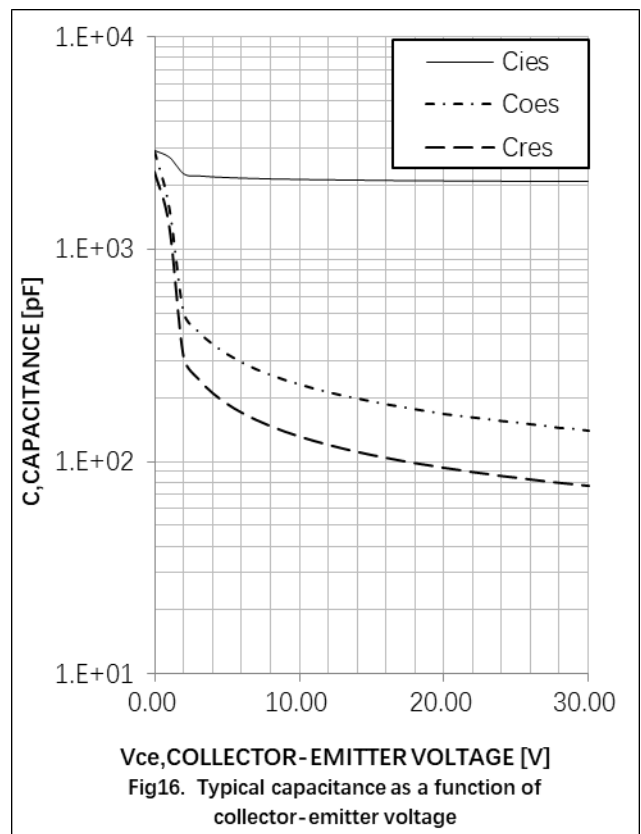
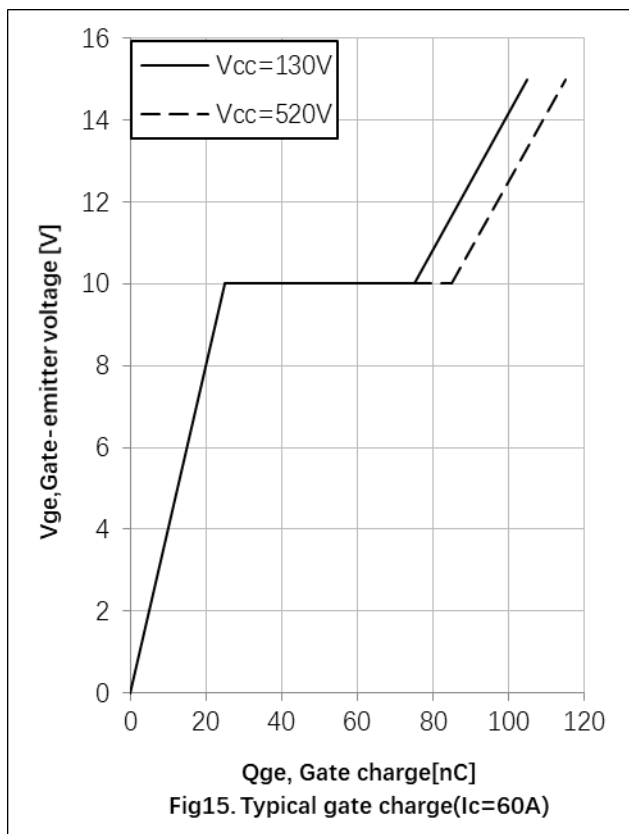
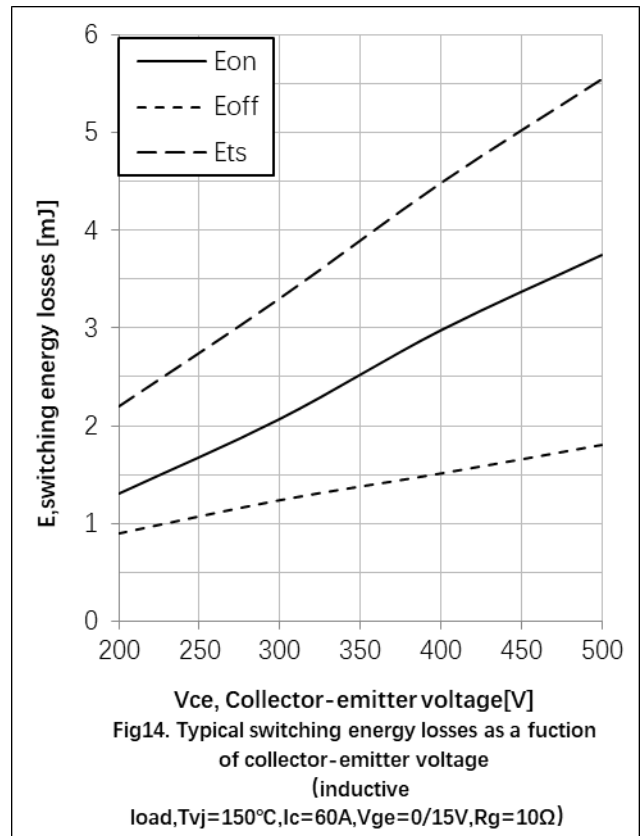
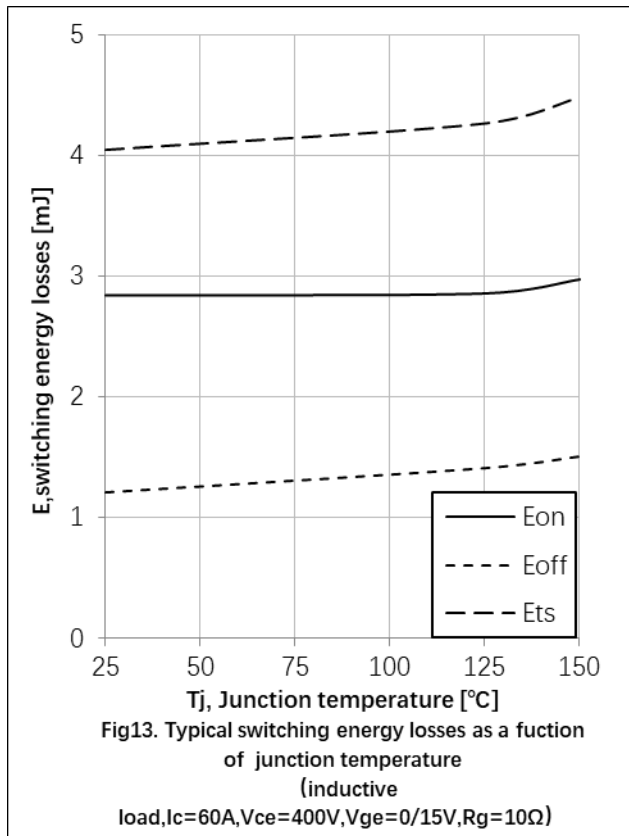
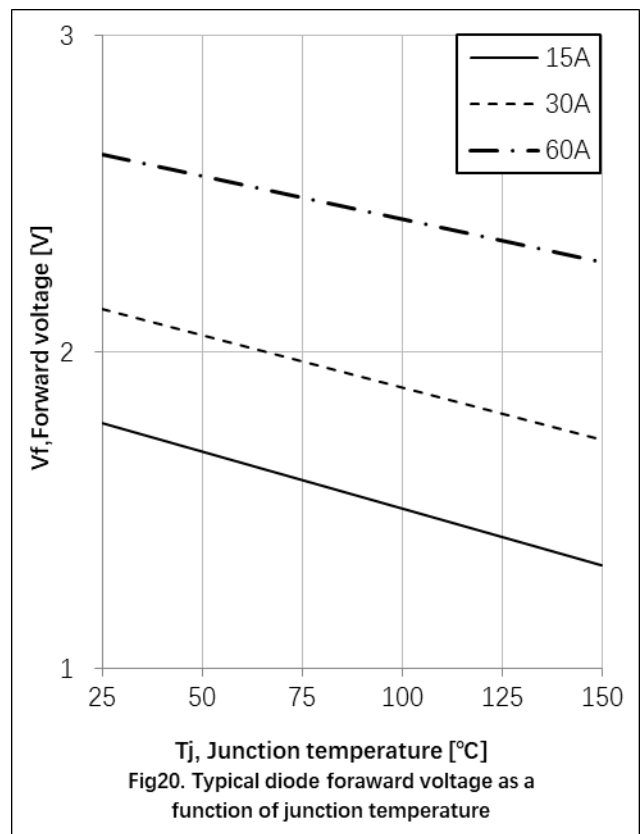
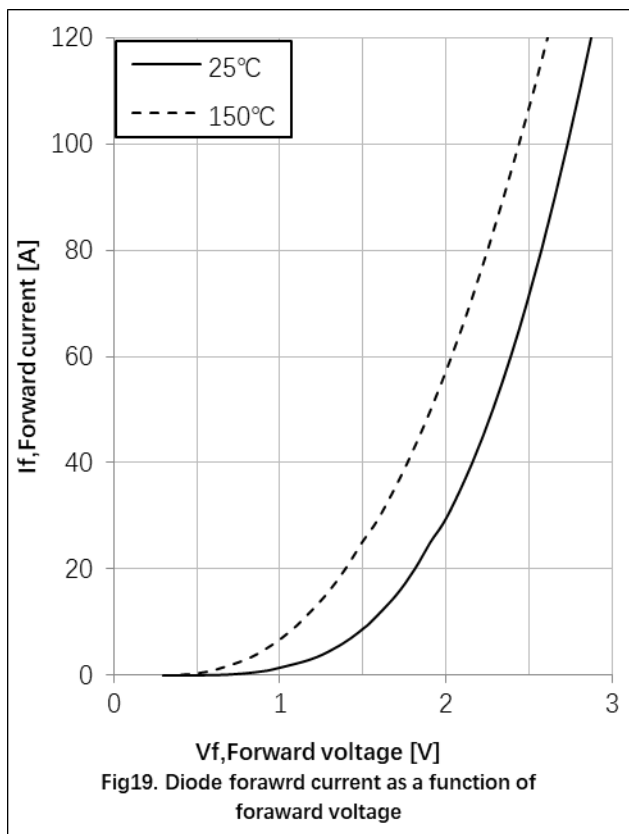
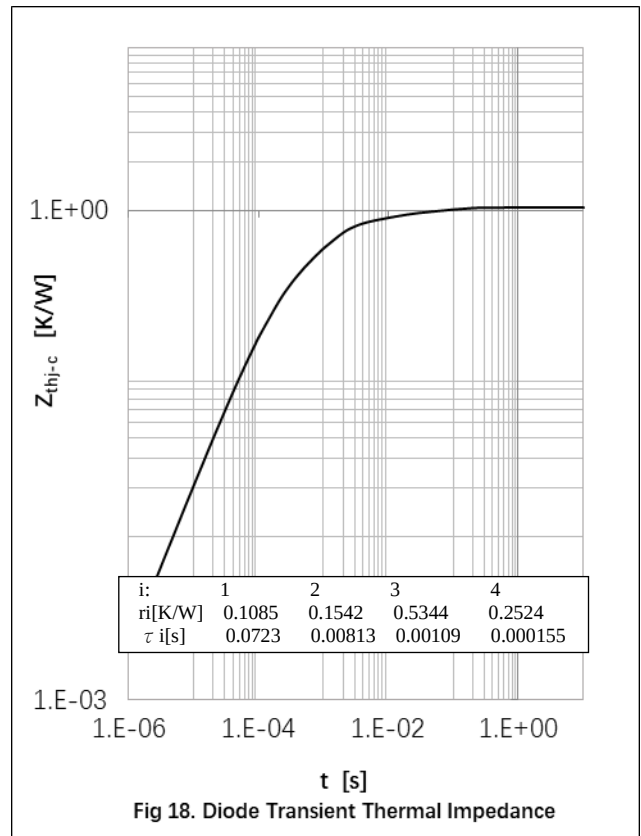
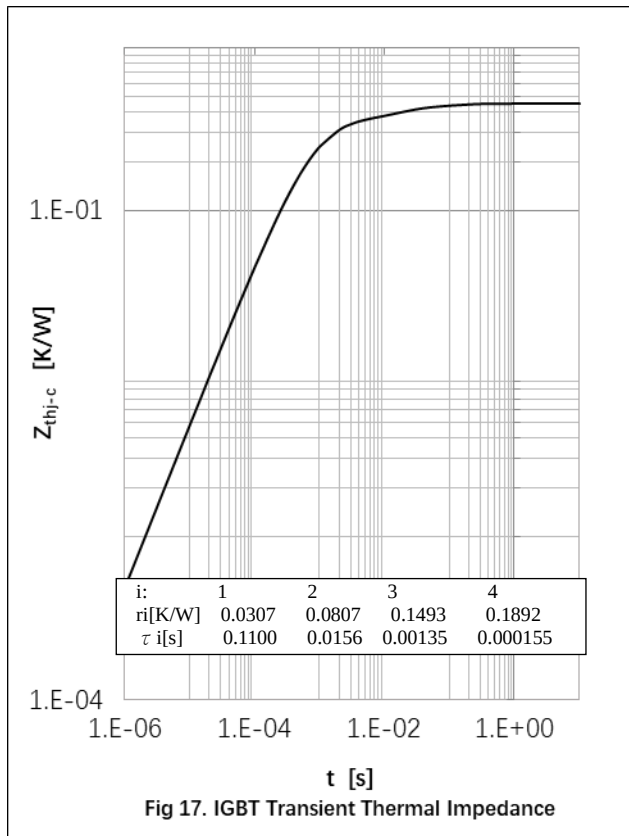


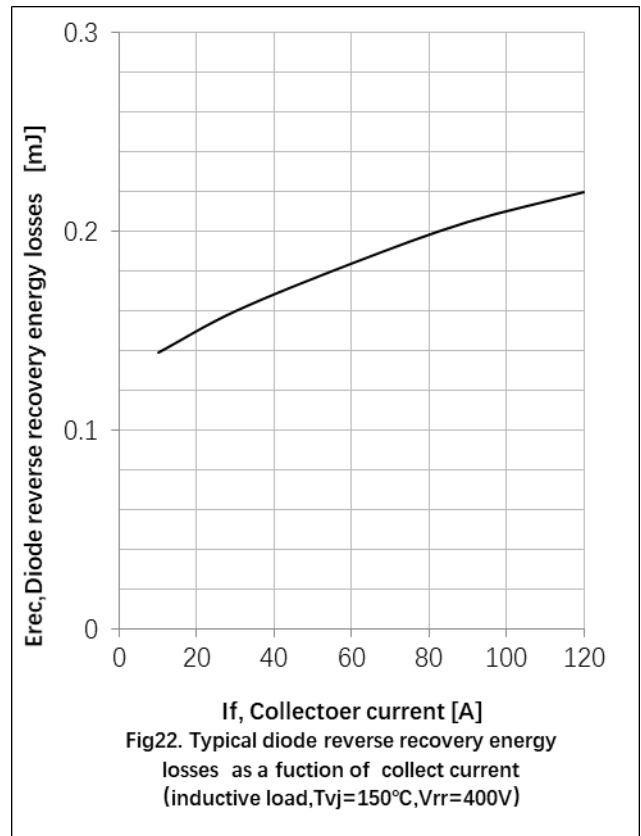
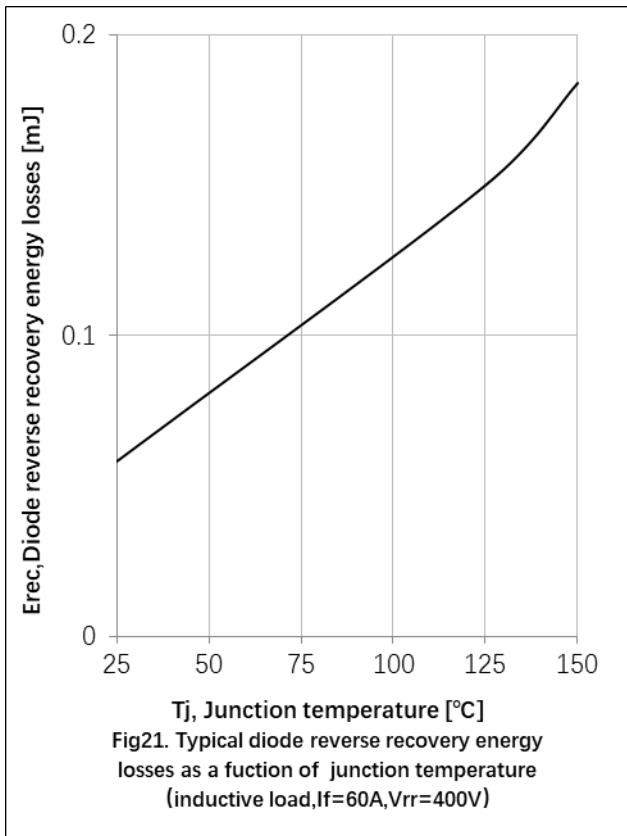
Fig4. Typical output characteristic ($T_j = 150^\circ\text{C}$)







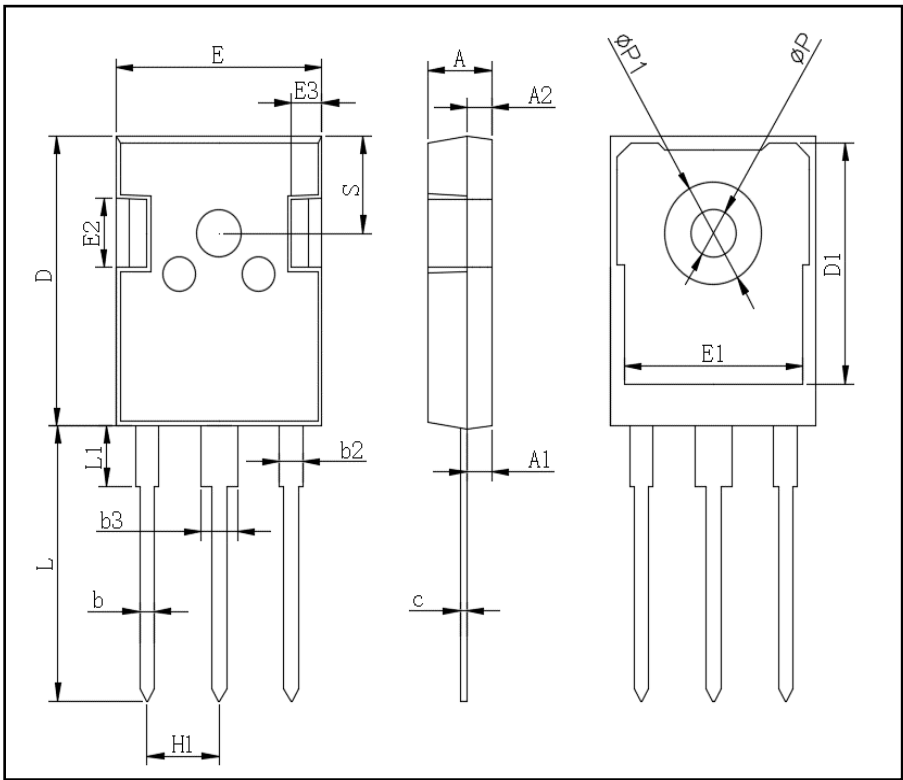




● Circuit Diagram



● Package Outline Information



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
ΦP	3.40	3.80
ΦP1	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20